

# U.S. UTILITY Patent Application

FF	O.I.P.E.	PATENT DATE
SCANNED <i>Guo</i>	Q.A. <i>Terrell</i>	

APPLICATION NO. 09/590897	CONT/PRIOR F	CLASS 257	SUBCLASS 723	ART UNIT 2811- 2922	EXAMINER <i>Mitchell</i> <i>Pratt</i>
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APPLICANTS

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Sealing structure for multi-chip module

TITLE

PTO-2040  
12/99

## ISSUING CLASSIFICATION

ORIGINAL		CROSS REFERENCE(S)					
CLASS	SUBCLASS	CLASS	SUBCLASS (ONE SUBCLASS PER BLOCK)				
INTERNATIONAL CLASSIFICATION							

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<input type="checkbox"/> <b>TERMINAL DISCLAIMER</b>	DRAWINGS			CLAIMS ALLOWED	
	Sheets Drwg.	Figs. Drwg.	Print Fig.	Total Claims	Print Claim for O.G.
<input type="checkbox"/> The term of this patent subsequent to _____ (date) has been disclaimed.	_____ (Assistant Examiner) (Date)			NOTICE OF ALLOWANCE MAILED	
<input type="checkbox"/> The term of this patent shall not extend beyond the expiration date of U.S. Patent. No. _____					
<input type="checkbox"/> The terminal _____ months of this patent have been disclaimed.	_____ (Primary Examiner) (Date)			ISSUE FEE	
				Amount Due	Date Paid
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